

# HSC226

Silicon Schottky Barrier Diode for High Speed Switching

REJ03G0599-0300 Rev.3.00 Sep 15, 2006

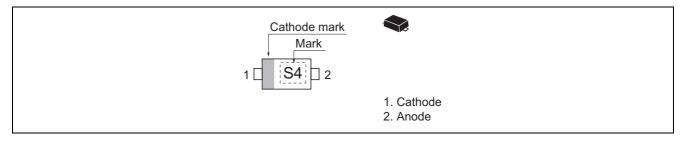
### Features

- Low reverse current, Low capacitance.
- Ultra small Flat Lead Package (UFP) is suitable for surface mount design.

### **Ordering Information**

Type No.	Cathode Mark	Package Name	Package Code
HSC226	S4	UFP	PWSF0002ZA-A

## **Pin Arrangement**





# Absolute Maximum Ratings

		$(Ta = 25^{\circ}C)$
Symbol	Value	Unit
V <sub>RRM</sub>	25	V
I <sub>FSM</sub> *	200	mA
IF	50	mA
Tj	125	°C
Tstg	-55 to +125	°C
	V <sub>RRM</sub> I <sub>FSM</sub> * I <sub>F</sub> Tj	V <sub>RRM</sub> 25           I <sub>FSM</sub> *         200           I <sub>F</sub> 50           Tj         125

Note: 10 ms Sine wave 1 pulse

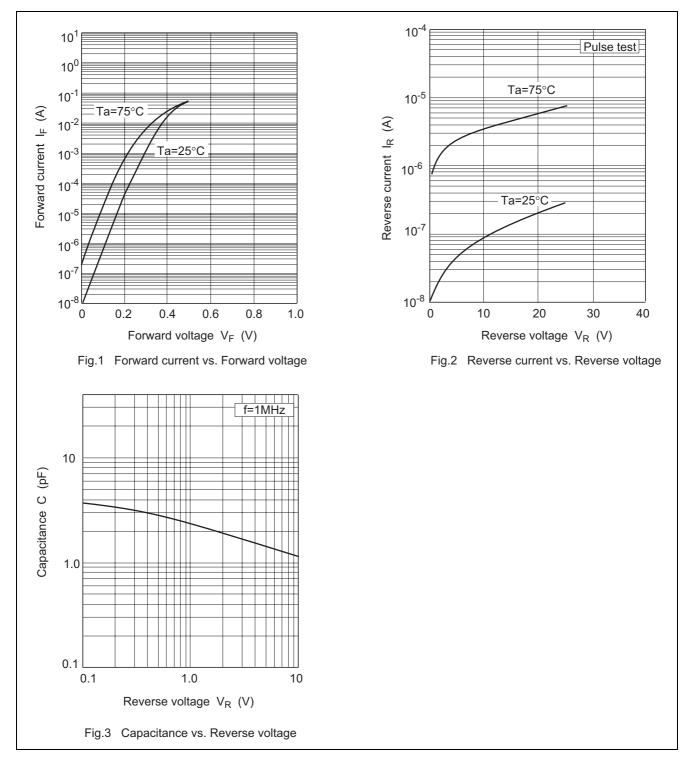
# **Electrical Characteristics**

 $(Ta = 25^{\circ}C)$ 

ltem	Symbol	Min	Тур	Max	Unit	Test Condition
Forward voltage	V <sub>F1</sub>	_	_	0.33	V	I <sub>F</sub> = 1 mA
	V <sub>F2</sub>	_	—	0.38		$I_F = 5 \text{ mA}$
Reverse current	I <sub>R</sub>	_	—	450	nA	V <sub>R</sub> = 20 V
Capacitance	С	_	—	2.80	pF	$V_{R} = 1 V, f = 1 MHz$

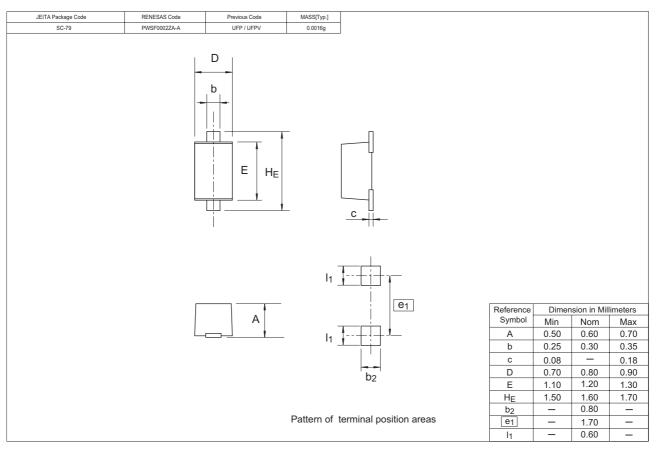


# **Main Characteristic**





# Package Dimensions





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